TOSHIBA LED Lamp InGaAlP Yellow Light Emission

TLYH156P

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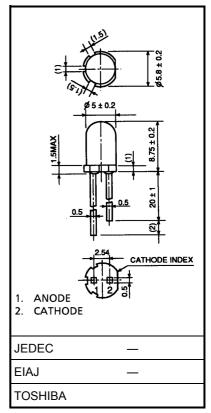
Panel Circuit Indicator

- 5 mm diameter (T1-3 / 4)
- InGaAlP yellow LED
- All plastic mold type.
- Colorless clear lens
- Low drive current, high intensity yellow light emission Recommended forward current: IF = $1\sim20$ mA (DC)
- All plastic molded lens, provides an excellent on-off contrast ratio.
- Fast response time, capable of pulse operation.
- High power luminous intensity
- Without stand-offs
- Applications: Suitable for outdoor message signbord, safety equipment, automotive use.

Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit	
Forward current (DC)	l _F	50	mA	
Reverse voltage	V _R	4	V	
Power dissipation	P _D	125	mW	
Operating temperature range	T _{opr}	-30~85	°C	
Storage temperature range	T _{stg}	−40~120	°C	

Unit in mm



Weight: 0.31 g

Electrical And Optical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition		Min	Тур.	Max	Unit
Forward voltage		V _F	I _F = 20 mA		_	2.1	2.5	V
Reverse current		I _R	V _R = 4 V		_	_	50	μΑ
Luminous	TLYH156P	- I _V	I _F = 20 mA	(Note)	476	1400	_	mcd
intensity	TLYH156P (RS)				476	_	2300	
Peak emission wavelength		λ _P	I _F = 20 mA		_	590	_	nm
Spectral line half width Δλ		Δλ	I _F = 20 mA		_	13	_	nm
Dominant wavelength		λ _d	I _F = 20 mA		_	587		nm

(Note): Lamps are classified into the following ranks according to their luminous intensity.

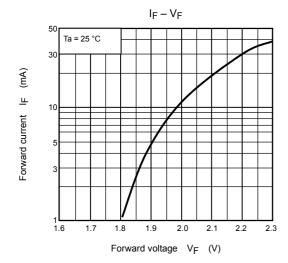
Measurement tolerance for each limit is ±15%.

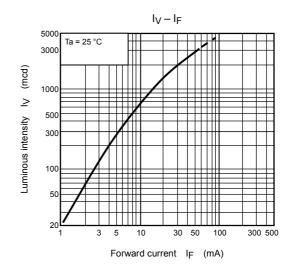
R: 560-1120 mcd, S: 1000-2000 mcd, T: 1800-3600 mcd.

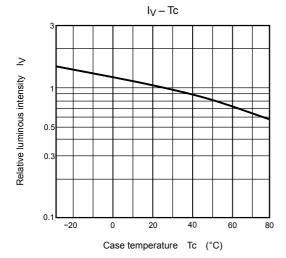
Precaution

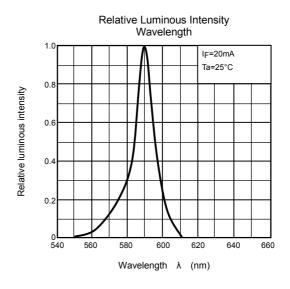
Please be careful of the followings

- Soldering temperature: 260°C max Soldering time: 3 s max (Soldering portion of lead: Up to 2 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.





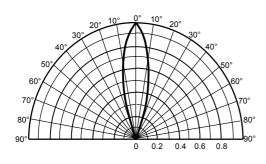


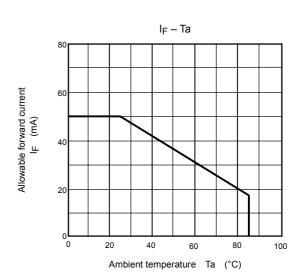


Radiation Pattern

Ta = 25 °C

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RESTRICTIONS ON PRODUCT USE

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